

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
(Not for submission under 37 CFR 1.99)

Application Number	10614744
Filing Date	2003-07-07
First Named Inventor	John A. Hicks III
Art Unit	2617
Examiner Name	Chuck Huynh
Attorney Docket Number	BS02500/ATTWP292US

U.S.PATENTS						Remove
Examiner Initial*	Cite No	Patent Number	Kind Code ¹	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
1	7200112			2007-04-03	Sundar, et al.	
2	7215959			2007-05-08	Creamer, et al.	
3	7277724			2007-10-02	Jones, et al.	
4	7502615			2009-03-10	Wilhoite, et al.	
5	7466991			2008-12-16	Everson, et al.	
6	7406324			2008-07-29	Von, K. McConnell	
7	7369856			2008-05-06	Shlomo Ovadia	
8	7039027			2006-05-02	Raj Bridgelall	

Receipt date: 03/27/2009			Application Number		10614744	10614744 - GAU: 2617
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)			Filing Date		2003-07-07	
			First Named Inventor		John A. Hicks III	
			Art Unit		2617	
			Examiner Name		Chuck Huynh	
			Attorney Docket Number		BS02500/ATTWP292US	

	9	6876852	B1	2005-04-05	Li, et al.	
--	---	---------	----	------------	------------	--

If you wish to add additional U.S. Patent citation information please click the Add button.

U.S.PATENT APPLICATION PUBLICATIONS

Examiner Initial*	Cite No	Publication Number	Kind Code ¹	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear
	1	20070153736	A1	2007-07-05	Mow, et al.	
	2	20040146021	A1	2004-07-29	Fors, et al.	
	3	20050286501	A1	2005-12-29	Mamoru Higuchi	
	4	20070083470	A1	2007-04-12	Bonner, et al.	

If you wish to add additional U.S. Published Application citation information please click the Add button.

FOREIGN PATENT DOCUMENTS

Examiner Initial*	Cite No	Foreign Document Number ³	Country Code ²	Kind Code ⁴	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	T ⁵
	1							<input type="checkbox"/>

If you wish to add additional Foreign Patent Document citation information please click the Add button

NON-PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.	T ⁵
--------------------	---------	---	----------------

Receipt date: 03/27/2009

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
(Not for submission under 37 CFR 1.99)

Application Number	10614744	10614744 - GAU: 2617
Filing Date	2003-07-07	
First Named Inventor	John A. Hicks III	
Art Unit	2617	
Examiner Name	Chuck Huynh	
Attorney Docket Number	BS02500/ATTWP292US	

1	OA mailed 3/25/09 for US Application Serial No. 11/513,720, 28 pages.	<input type="checkbox"/>
2	Final OA mailed 3/17/09 for US Application Serial No. 10/614,737, 34 pages.	<input type="checkbox"/>

If you wish to add additional non-patent literature document citation information please click the Add button

EXAMINER SIGNATURE

Examiner Signature	/Chuck Huynh/	Date Considered	06/18/2009
--------------------	---------------	-----------------	------------

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ See Kind Codes of USPTO Patent Documents at www.USPTO.GOV or MPEP 901.04. ² Enter office that issued the document, by the two-letter code (WIPO Standard ST.3). ³ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁴ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁵ Applicant is to place a check mark here if English language translation is attached.